Input Voltage = 12Vin - 67Vin

Note:
1. C4x and C23x are ceramic caps stacked on top of each other on one single footprint.
2. Rx1, Rx2, Rx3, Rx4, Dx1 and Dx2 are kludged on the board, don't have dedicated footprint on the PCB.
Assembly Note ZZ2
These assemblies are ESD sensitive, ESD precautions shall be observed.

Assembly Note ZZ3
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Assembly Note ZZ4
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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